



DMP32D4SW

30V P-CHANNEL ENHANCEMENT MODE MOSFET

Product Summary

V _{(BR)DSS}	R _{DS(on)} Max	I _D Max @ T _A = 25°C
-30V	2.4Ω @ V _{GS} = -10V	-250mA
-30 v	4Ω @ V _{GS} = -4.5V	-200mA

Description

This MOSFET has been designed to minimize the on-state resistance $(R_{DS(on)})$ and yet maintain superior switching performance, making it ideal for high efficiency power management applications.

Applications

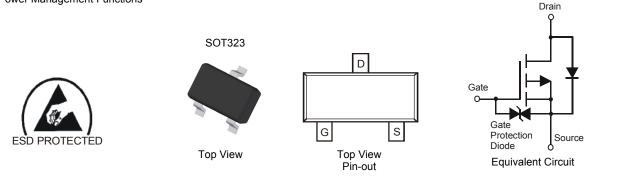
- Load Switch
- Portable Applications
- Power Management Functions

Features

- Low On-Resistance
- ESD Protected Gate
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- Qualified to AEC-Q101 Standards for High Reliability

Mechanical Data

- Case: SOT323
- Case Material: Molded Plastic, "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Lead Free Plating (Matte Tin Finish annealed over Alloy 42 leadframe).
- Weight: 0.006 grams (approximate)



Ordering Information (Note 4)

Product	Marking	Reel size (inches)	Quantity per reel
DMP32D4SW-7	P32D	7	3,000
DMP32D4SW-13	P32D	13	10,000

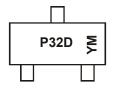
Notes: 1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant.

 See http://www.diodes.com/quality/lead_free.html for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.

3. Halogen and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.</p>

4. For packaging details, go to our website at http"//www.diodes.com/products/packages.html.

Marking Information



P32D = Product Type Marking Code YM = Date Code Marking Y = Year (ex: Z = 2012) M = Month (ex: 9 = September)

Date Code Key

Date Code Key												
Year	201	2	2013		2014	20	15	2016		2017	2	2018
Code	Z		А		В	(C (D		E		F
Month	Jan	Feb	Mar	Apr	Мау	Jun	Jul	Aug	Sep	Oct	Nov	Dec
Code	1	2	3	4	5	6	7	8	9	0	N	D



Maximum Ratings (@T_A = +25°C, unless otherwise specified.)

Character	istic		Symbol	Value	Unit
Drain-Source Voltage			V _{DSS}	-30	V
Gate-Source Voltage			V _{GSS}	±20	V
Continuous Drain Current (Note 6)	Current (Note 6) $V_{GS} = -10V$ $T_A = +25^{\circ}C$ $T_A = +70^{\circ}C$		I _D	250 200	mA
Pulsed Drain Current (Note 6)			I _{DM}	-1	А

Thermal Characteristics (@T_A = +25°C, unless otherwise specified.)

Characteristic		Symbol	Value	Units	
Total Power Dissipation	(Note 5)	P	300	mW	
	(Note 6)	PD	432	11100	
Thermal Desistance, Junction to Ambient	(Note 5)	D	398		
Thermal Resistance, Junction to Ambient	(Note 6)	R _{θJA}	290	°C/W	
Thermal Resistance, Junction to Case	(Note 5)	R _{θJC}	142		
Operating and Storage Temperature Range		T _J , T _{STG}	-55 to 150	°C	

Electrical Characteristics (@T_A = +25°C, unless otherwise specified.)

			_			
Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition
OFF CHARACTERISTICS (Note 7)				1		
Drain-Source Breakdown Voltage	BV _{DSS}	-30	-	-	V	$V_{GS} = 0V, I_{D} = -1mA$
Zero Gate Voltage Drain Current T _J = +25°C	I _{DSS}	-	-	-1	μA	V _{DS} = -30V, V _{GS} = 0V
Gate-Source Leakage	IGSS	-	-	±10	μA	$V_{GS} = \pm 16V, V_{DS} = 0V$
ON CHARACTERISTICS (Note 7)						
Gate Threshold Voltage	V _{GS(th)}	-1.4	-	-2.4	V	V_{DS} = V_{GS} , I_D = -250 μ A
Static Drain-Source On-Resistance	Provin	-	_	2.4	Ω	V_{GS} = -10V, I_{D} = -0.5A
	R _{DS (ON)}	-	-	4	32	V_{GS} = -4.5V, I_{D} = -0.3A
Forward Transfer Admittance	Y _{fs}	-	6	-	S	V_{DS} = -10V, I_{D} = -400mA
Diode Forward Voltage	V _{SD}	-	0.8	1.2	V	V _{GS} = 0V, I _S = -300mA
DYNAMIC CHARACTERISTICS (Note 8)						
Input Capacitance	C _{iss}	-	51.16	-	pF	
Output Capacitance	C _{oss}	-	10.85	-	pF	−V _{DS} = -15V, V _{GS} = 0V, −f = 1.0MHz
Reverse Transfer Capacitance	C _{rss}	-	8.88	-	pF	1 - 1:00012
Gate Resistance	Rg	-	275	-	Ω	$V_{DS} = 0V, V_{GS} = 0V, f = 1MHz$
Total Gate Charge	Qg	-	0.6	-	nC	$V_{GS} = -4.5V$
Total Gate Charge	Qg	-	1.2	-	nC	V _{DS} = -10V,
Gate-Source Charge	Q _{gs}	-	0.2	-	nC	V _{GS} = -10V I _D = -1A
Gate-Drain Charge	Q _{gd}	-	0.3	-	nC	
Turn-On Delay Time	t _{D(on)}	-	9.86	-	ns	
Turn-On Rise Time	tr	-	11.5	-	ns	V _{DS} = -15V, I _D = -1A
Turn-Off Delay Time	t _{D(off)}	-	31.8	-	ns	V _{GS} = -10V, R _G = 6Ω
Turn-Off Fall Time	t _f	-	21.9	-	ns	

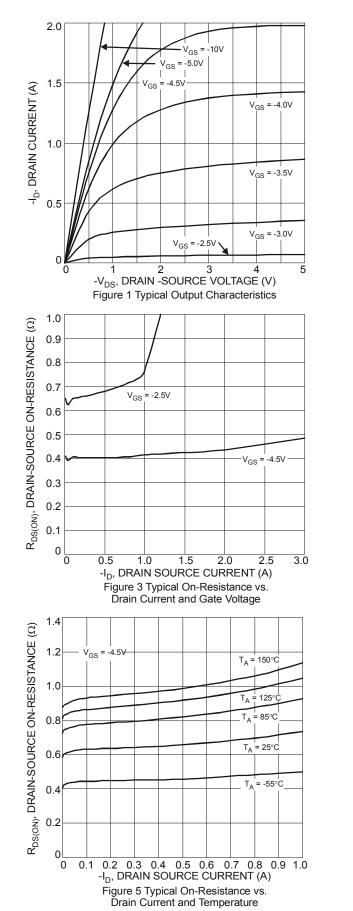
Notes:

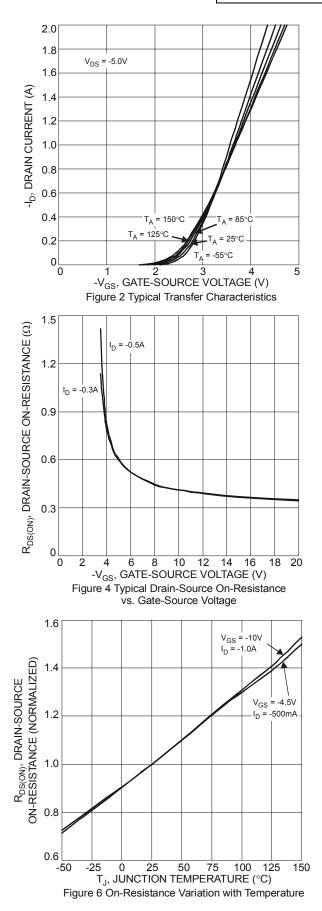
5. Device mounted on FR-4 PC board, with minimum recommended pad layout, single sided.

Device mounted on FR-4 substrate PC board, with minimum recommended pad ayout, single sided.
Device mounted on FR-4 substrate PC board, 2oz copper, with 1inch square copper pad layout 7 .Short duration pulse test used to minimize self-heating effect.
Guaranteed by design. Not subject to production testing.

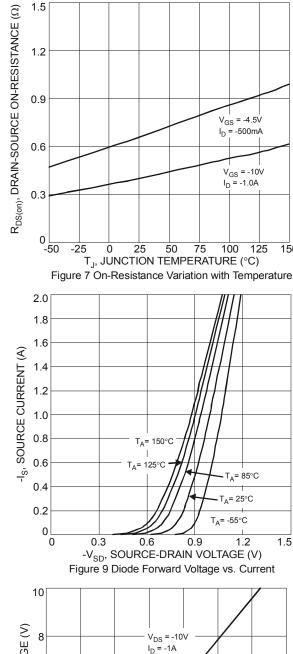


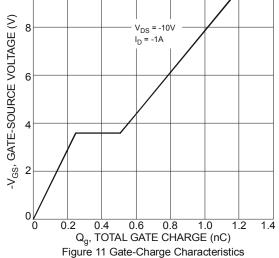
NEW PRODUCT

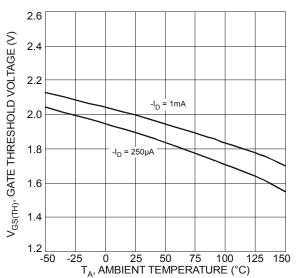




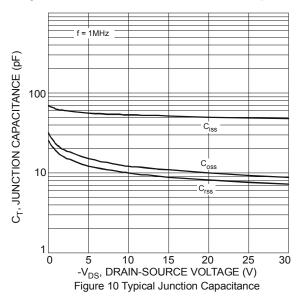












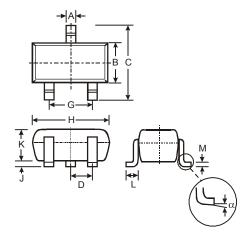
150

1.5



Package Outline Dimensions

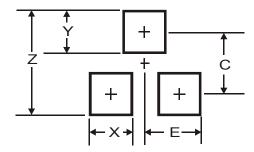
Please see AP02002 at http://www.diodes.com/datasheets/ap02002.pdf for latest version.



SOT323							
Dim	Min	Max	Тур				
Α	0.25	0.40	0.30				
в	1.15	1.35	1.30				
С	2.00	2.20	2.10				
D	-	-	0.65				
G	1.20	1.40	1.30				
Н	1.80	2.20	2.15				
J	0.0	0.10	0.05				
κ	0.90	1.00	0.95				
L	0.25	0.40	0.30				
Μ	0.10	0.18	0.11				
α	0°	8°	-				
All	Dimens	ions in	mm				

Suggested Pad Layout

Please see AP02001 at http://www.diodes.com/datasheets/ap02001.pdf for the latest version.



Dimensions	Value (in mm)
Z	2.8
Х	0.7
Y	0.9
С	1.9
E	1.0



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